MCP809,MCP810

MCP809/MCP810 3-Pin Microprocessor Reset Circuits



Literature Number: SNVS165



MCP809/MCP810

3-Pin Microprocessor Reset Circuits

General Description

The MCP809/810 microprocessor supervisory circuits can be used to monitor the power supplies in microprocessor and digital systems. They provide a reset to the microprocessor during power-up, power-down and brown-out conditions.

The function of the MCP809/810 is to monitor the $V_{\rm CC}$ supply voltage, and assert a reset signal whenever this voltage declines below the factory-programmed reset threshold. The reset signal remains asserted for 240ms after $V_{\rm CC}$ rises above the threshold. The MCP809 has an active-low $\overline{\rm RESET}$ output, while the MCP810 has an active-high RESET output.

Seven standard reset voltage options are available, suitable for monitoring 5V, 3.3V, and 3V supply voltages.

With a low supply current of only $15\mu A$, the MCP809/810 are ideal for use in portable equipment. The MCP809/MCP810 are available in the 3-pin SOT23 package.

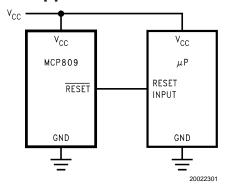
Features

- Precise monitoring of 3V, 3.3V, and 5V supply voltages
- Fully specified over temperature
- 140ms min. Power-On Reset pulse width, 240ms typical Active-low RESET Output (MCP809)
 Active-high RESET Output (MCP810)
- Guaranteed RESET Output valid for V_{CC}≥1V
- Low Supply Current, 15µA typ.
- Power supply transient immunity

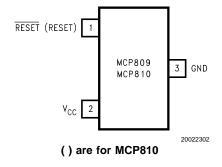
Applications

- Microprocessor Systems
- Computers
- Controllers
- Intelligent Instruments
- Portable/Battery-Powered Equipment
- Automotive

Typical Application Circuit



Connection Diagram



Ordering Information

Reset Threshold	MCP809 Supplied as	MCP809 Supplied as	Package	Package	
(V)	1000 units, tape & reel	3000 units, tape & reel	Top Mark	Туре	NSC Package
4.63	MCP809M3-4.63	MCP809M3X-4.63	SVB		
4.38	MCP809M3-4.38	MCP809M3X-4.38	SUB		MF03A
4.00	MCP809M3-4.00	MCP809M3X-4.00	STB	SOT23-3	
3.08	MCP809M3-3.08	MCP809M3X-3.08	SSB	50123-3	
2.93	MCP809M3-2.93	MCP809M3X-2.93	SRB		
2.63	MCP809M3-2.63	MCP809M3X-2.63	SPB		
Reset Threshold	MCP810 Supplied as	MCD040 Cumplied as	Daalaana	Daalaaaa	
	MICFOID Supplied as	MCP810 Supplied as	Package	Package	
(V)	1000 units, tape & reel	3000 units, tape & reel	Раскаде Top Mark	Туре	NSC Package
			•		NSC Package
(V)	1000 units, tape & reel	3000 units, tape & reel	Top Mark		NSC Package
(V) 4.63	1000 units, tape & reel MCP810M3-4.63	3000 units, tape & reel MCP810M3X-4.63	Top Mark SNB	Туре	
(V) 4.63 4.38	1000 units, tape & reel MCP810M3-4.63 MCP810M3-4.38	3000 units, tape & reel MCP810M3X-4.63 MCP810M3X-4.38	Top Mark SNB SLB		NSC Package MF03A
(V) 4.63 4.38 4.00	1000 units, tape & reel MCP810M3-4.63 MCP810M3-4.38 MCP810M3-4.00	3000 units, tape & reel MCP810M3X-4.63 MCP810M3X-4.38 MCP810M3X-4.00	Top Mark SNB SLB SKB	Туре	

Custom voltages and improved accuracies are available, subject to minimum orders. Contact your local National Semiconductor Sales Office for information.

Pin Description

PIN	NAME	FUNCTION		
3	GND	Ground reference		
1	PECEL MAIL DANG	Active-low output. $\overline{\text{RESET}}$ remains low while V_{CC} is below the reset threshold, and for 240ms after V_{CC} rises above the reset threshold.		
'	RESEL (MCP810)	Active-high output. RESET remains high while $V_{\rm CC}$ is below the reset threshold, and for 240ms after $V_{\rm CC}$ rises above the reset threshold.		
2	V _{CC}	Supply Voltage (+5V, +3.3V, or +3.0V)		

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

 $\begin{array}{ccc} \rm V_{CC} & -0.3V \ to \ 6.0V \\ \rm RESET, \ \overline{RESET} & -0.3V \ to \ (V_{CC} + 0.3V) \\ \rm Input \ Current, \ V_{CC} \ Pin & 20mA \\ \rm Output \ Current, \ RESET, \ \overline{RESET} & \end{array}$

Pin 20mA Rate of Rise, V_{CC} 100V/ μ s

ESD Rating (Note 2) 2kV Continuous Power Dissipation ($T_A = +70^{\circ}C$) 320mW Ambient Temperature Range $-40^{\circ}C$ to $+105^{\circ}C$ Maximum Junction Temperature $125^{\circ}C$ Storage Temperature Range $-65^{\circ}C$ to $+160^{\circ}C$ Lead Temperature (soldering, $+300^{\circ}C$

Electrical Characteristics

 V_{CC} = full range, T_A = -40°C to +105°C, unless otherwise noted. Typical values are at T_A = +25°C, V_{CC} = 5V for 4.63/4.38/4.00 versions, V_{CC} = 3.3V for 3.08/2.93 versions, and V_{CC} = 3V for 2.63 version. (Note 4)

Symbol	Parameter	C	Conditions	Min	Тур	Max	Units
	V Dense	$T_A = 0^{\circ}C \text{ to } +70^{\circ}C$ $T_A = -40^{\circ}C \text{ to } +105^{\circ}C$		1.0		5.5	V
	V _{CC} Range			1.2		5.5	1 V
		$T_A = -40^{\circ}C \text{ to} +85^{\circ}C$	V _{CC} <5.5V, MCP8 -4.63/4.38/4.00		18	60	
I _{cc}	Supply Current		V _{CC} <3.6V, MCP8 3.08/2.93/2.63		15	50	
		$T_A = +85^{\circ}C \text{ to} +105^{\circ}C$	V _{CC} <5.5V, MCP8 -4.63/4.38/4.00			100	μA
			V _{CC} <3.6V, MCP8 -3.08/2.93/2.63 T _A = +25°C 4.56			100	
			T _A = +25°C	4.56	4.63	4.70	
		MCP84.63	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	4.50		4.75	V
	Reset Threshold (Note 5)		$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	4.40		4.86	
			$T_A = +25^{\circ}C$	4.31	4.38	4.45	
		MCP84.38	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	4.25		4.50	
			$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	4.16		4.56	
		MCP84.00	$T_A = +25^{\circ}C$	3.93	4.00	4.06	
			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	3.89		4.10	
			$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	3.80		4.20	
V_{TH}		MCP83.08	$T_A = +25^{\circ}C$	3.04	3.08	3.11	
			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	3.00		3.15	
			$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	2.92		3.23	
		MCP82.93	$T_A = +25^{\circ}C$	2.89	2.93	2.96	
			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	2.85		3.00	
			$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	2.78		3.08	
		MCP82.63 T _A	$T_A = +25^{\circ}C$	2.59	2.63	2.66	
			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	2.55		2.70	
			$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$	2.50		2.76	
	Reset Threshold Temperature Coefficient				30		ppm/°C
	V _{CC} to Reset Delay (Note 5)	$V_{CC} = V_{TH}$ to (V_{TH})	₋ – 100mV)		20		μs
	Reset Active Timeout Period	$T_A = -40^{\circ}C \text{ to } +89$	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		240	560	me
	Reset Active Timeout Period	$T_A = +85^{\circ}C \text{ to } +105^{\circ}C$		100		840	ms

Electrical Characteristics (Continued)

 V_{CC} = full range, T_A = -40°C to +105°C, unless otherwise noted. Typical values are at T_A = +25°C, V_{CC} = 5V for 4.63/4.38/4.00 versions, V_{CC} = 3.3V for 3.08/2.93 versions, and V_{CC} = 3V for 2.63 version. (Note 4)

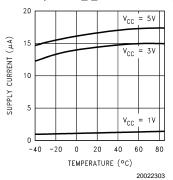
Symbol	Parameter	Conditions	Min	Тур	Max	Units
V _{OL}	RESET Output Voltage Low (MCP809)	$V_{CC} = V_{TH} \text{ min, } I_{SINK} = 1.2\text{mA,}$ MCP809-2.63/2.93/3.08			0.3	
		$V_{CC} = V_{TH} \text{ min, } I_{SINK} = 3.2\text{mA,}$ MCP809-4.63/4.38/4.00			0.4	0.4 V
		$V_{CC} > 1.0V$, $I_{SINK} = 50\mu A$			0.3	
Vou	RESET Output Voltage High (MCP809)	$V_{CC} > V_{TH} \text{ max}, I_{SOURCE} = 500 \mu\text{A},$ MCP809-2.63/2.93/3.08	0.8V _{CC}			V
		$V_{CC} > V_{TH} \text{ max}, I_{SOURCE} = 800 \mu\text{A},$ MCP809-4.63/4.38/4.00	V _{CC} -1.5			
V _{OL}	RESET Output Voltage Low (MCP810)	$V_{CC} = V_{TH} \text{ max}, I_{SINK} = 1.2\text{mA},$ MCP810-2.63/2.93/3.08			0.3	0.3 0.4
		$V_{CC} = V_{TH} \text{ max}, I_{SINK} = 3.2\text{mA},$ MCP810-4.63/4.38/4.00			0.4	
V _{OH}	RESET Output Voltage High (MCP810)	$1.8V < V_{CC} < V_{TH}$ min, $I_{SOURCE} = 150\mu A$	0.8V _{CC}			V

Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which the device operates correctly. Operating ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics.

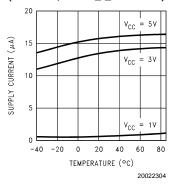
- Note 2: The human body model is a 100pF capacitor discharged through a $1.5k\Omega$ resistor into each pin.
- **Note 3:** Production testing done at $T_A = +25^{\circ}C$, over temperature limits guaranteed by design only.
- Note 4: At elevated temperatures, devices must be derated based on package thermal resistance. The device in the SOT23-3 package must be derated at 4mW/°C at ambient temperatures above 70°C. The device has internal thermal protection.
- Note 5: RESET Output for MCP809, RESET output for MCP810.

Typical Performance Characteristics

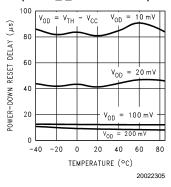
Supply Current vs Temperature (No Load, MCP8_ _-2.63/2.93/3.08)



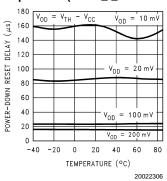
Supply Current vs Temperature (No Load, MCP8_ _-4.63/4.38)



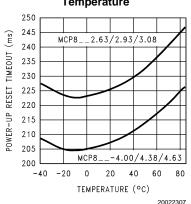
Power-Down Reset Delay vs Temp (MCP8_ _-2.63/2.93/3.08)



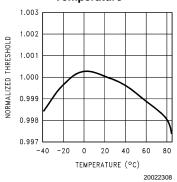
Power-Down Reset Delay vs Temperature (MCP8_ _-4.63/4.38)



Power-Up Reset Timeout vs Temperature



Normalized Reset Threshold vs Temperature



Applications Information

Benefits of Precision Reset Thresholds

A microprocessor supply supervisor must provide a reset output within a predictable range of the supply voltage. A common threshold range is between 5% and 10% below the nominal supply voltage. The 4.63V and 3.08V options of the MCP809/810 use highly accurate circuitry to ensure that the reset threshold occurs only within this range (for 5V and 3.3V supplies). The other voltage options have the same tight tolerance to ensure a reset signal for other narrow monitor ranges. See *Table 1* for examples of how the standard reset thresholds apply to 3V, 3.3V, and 5V nominal supply voltages.

TABLE 1. Reset Thresholds Related to Common Supply Voltages

Reset Threshold	3.0V	3.3V	5.0V
4.63 ± 3%			90 - 95%
4.38 ± 3%			85 - 90%
4.00 ± 3%			78 - 82%
3.08 ± 3%		90 - 95%	
2.93 ± 3%		86 - 90%	
2.63 ± 3%	85 - 90%	77 - 81%	

Ensuring a Valid Reset Output Down to V_{CC} = 0V

When V_{CC} falls below 1V, the MCP809 \overline{RESET} output no longer sinks current. A high-impedance CMOS logic input connected to \overline{RESET} can therefore drift to undetermined voltages. To prevent this situation, a $100k\Omega$ resistor should be connected from the \overline{RESET} output to ground, as shown in Figure 1.

A $100 \mathrm{k}\Omega$ pull-up resistor to V_CC is also recommended for the MCP810, if RESET is required to remain valid for V_CC < 1V.

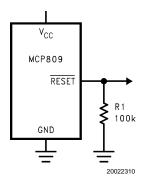


FIGURE 1. $\overline{\text{RESET}}$ Valid to V_{CC} = Ground Circuit

Negative-Going V_{CC} Transients

The MCP809/810 are relatively immune to short negative-going transients or glitches on $V_{\rm CC}$. Figure 2 shows the maximum pulse width a negative-going $V_{\rm CC}$ transient

can have without causing a reset pulse. In general, as the magnitude of the transient increases, going further below the threshold, the maximum allowable pulse width decreases. Typically, for the 4.63V and 4.38V version of the MCP809/810, a $V_{\rm CC}$ transient that goes 100mV below the reset threshold and lasts 20 μ s or less will not cause a reset pulse. A 0.1 μ F bypass capacitor mounted as close as possible to the $V_{\rm CC}$ pin will provide additional transient rejection.

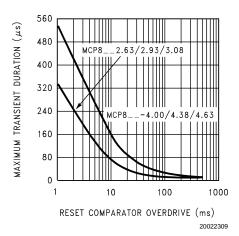


FIGURE 2. Maximum Transient Duration without Causing a Reset Pulse vs. Reset Comparator Overdrive

Interfacing to µPs with Bidirectional Reset Pins

Microprocessors with bidirectional reset pins, such as the Motorola 68HC11 series, can be connected to the MCP809 $\overline{\text{RESET}}$ output. To ensure a correct output on the MCP809 even when the microprocessor reset pin is in the opposite state, connect a 4.7k Ω resistor between the MCP809 $\overline{\text{RE-SET}}$ output and the μP reset pin, as shown in Figure 3. Buffer the MCP809 $\overline{\text{RE-SET}}$ output to other system components.

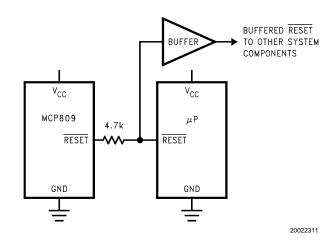
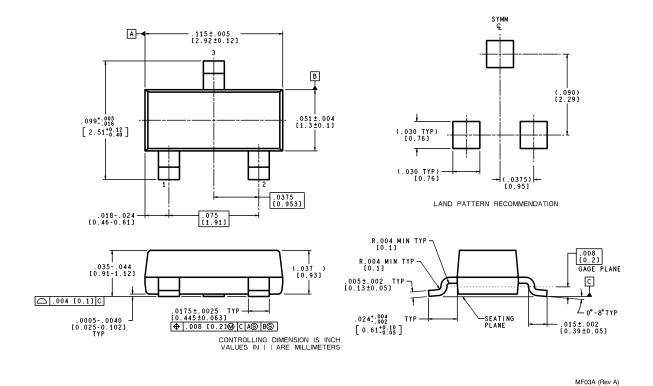


FIGURE 3. Interfacing to Microprocessors with Bidirectional Reset I/O

Physical Dimensions inches (millimeters)

unless otherwise noted



3-Lead SOT23-3 For Ordering, refer to Ordering Information table **NS Package Number MF03A**

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